

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of: **Kenichi FUJITA**

Group Art Unit: **Not Yet Assigned**

Serial No.: **Not Yet Assigned**

Examiner: **Not Yet Assigned**

Filed: **September 12, 2003**

For: **HEAT RADIATION SHIELDING COMPONENT DISPERSION, PROCESS FOR ITS PREPARATION AND HEAT RADIATION SHIELDING FILM FORMING COATING LIQUID, HEAT RADIATION SHIELDING FILM AND HEAT RADIATION SHIELDING RESIN FORM WHICH ARE OBTAINED USING THE DISPERSION**

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Date: September 12, 2003

Sir:

Prior to calculation of the filing fee and examination of this application, please amend the above-identified patent application as follows: